

## CD74ACT14 Hex Schmitt-Trigger Inverter

### 1 Features

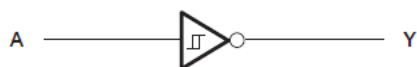
- Inputs are TTL-voltage compatible
- Speed of bipolar F, AS, and S, with significantly reduced power consumption
- Greater noise immunity than standard inverters
- Operates with much slower than standard input rise and fall slew rates
- $\pm 24$ -ma output drive current
  - Fanout to 15 F devices
- SCR-latchup-resistant CMOS process and circuit design

### 2 Description

The CD74ACT14 contains six independent inverters. This device performs the Boolean function  $Y = \bar{A}$ .

#### Package Information

| PART NUMBER | PACKAGE <sup>1</sup> | PACKAGE SIZE <sup>2</sup> |
|-------------|----------------------|---------------------------|
| CD74ACT14   | D (SOIC, 14)         | 8.65 mm x 6 mm            |
|             | N (PDIP, 14)         | 19.3 mm x 9.4 mm          |



Logic Diagram (Positive Logic)



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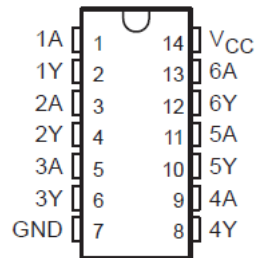
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### 3 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| <b>Changes from Revision A (November 2004) to Revision B (August 2023)</b>  | <b>Page</b> |
|---|-------------|
| • Added <i>Package Information</i> table, <i>Pin Functions</i> table, <i>ESD Ratings</i> table, <i>Thermal Information</i> table, <i>Device Functional Modes</i> , <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section ..... | <b>1</b>    |

## 4 Pin Configuration and Functions



**Figure 4-1. CD74AC04 E or M Package (Top View)**

**Table 4-1. Pin Functions**

| PIN             |     | I/O    | DESCRIPTION         |
|-----------------|-----|--------|---------------------|
| NAME            | NO. |        |                     |
| 1A              | 1   | Input  | Channel 1, Input A  |
| 1Y              | 2   | Output | Channel 1, Output Y |
| 2A              | 3   | Input  | Channel 2, Input A  |
| 2Y              | 4   | Output | Channel 2, Output Y |
| 3A              | 5   | Input  | Channel 3, Input A  |
| 3Y              | 6   | Output | Channel 3, Output Y |
| GND             | 7   | —      | Ground              |
| 4Y              | 8   | Output | Channel 4, Output Y |
| 4A              | 9   | Input  | Channel 4, Input A  |
| 5Y              | 10  | Output | Channel 5, Output Y |
| 5A              | 11  | Input  | Channel 5, Input A  |
| 6Y              | 12  | Output | Channel 6, Output Y |
| 6A              | 13  | Input  | Channel 6, Input A  |
| V <sub>CC</sub> | 14  | —      | Positive Supply     |

## 5 Specifications

### 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)

|            |   | MIN  | MAX  | UNIT |
|------------|---|------|------|------|
| $V_{CC}$   | Supply voltage  | -0.5 | 6    | V    |
| $I_{IK}^1$ | Input clamp current<br>( $V_I < 0$ or $V_I > V_{CC}$ )  |      | ±20  | mA   |
| $I_{OK}^1$ | Output clamp current<br>( $V_O < 0$ or $V_O > V_{CC}$ ) |      | ±50  | mA   |
| $I_O$      | Continuous output current<br>( $V_O = 0$ to $V_{CC}$ )  |      | ±50  | mA   |
|            | Continuous current through $V_{CC}$ or GND              |      | ±100 | mA   |
| $T_{stg}$  | Storage temperature                                     | -65  | 150  | °C   |

### 5.2 ESD Ratings

|             |  | VALUE | UNIT |
|-------------|--|-------|------|
| $V_{(ESD)}$ | Electrostatic discharge<br>Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup> | ±2000 | V    |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

### 5.3 Recommended Operating Conditions

|                         |                                    | TA = 25°C |          | - 55°C to 125°C |          | - 40°C to 85°C |          | UNIT |
|-------------------------|------------------------------------|-----------|----------|-----------------|----------|----------------|----------|------|
|                         |                                    | MIN       | MAX      | MIN             | MAX      | MIN            | MAX      |      |
| $V_{CC}$                | Supply voltage                     | 4.5       | 5.5      | 4.5             | 5.5      | 4.5            | 5.5      | V    |
| $V_I$                   | Input voltage                      | 0         | $V_{CC}$ | 0               | $V_{CC}$ | 0              | $V_{CC}$ | V    |
| $V_O$                   | Output voltage                     | 0         | $V_{CC}$ | 0               | $V_{CC}$ | 0              | $V_{CC}$ | V    |
| $I_{OH}$                | High-level output current          |           | -24      |                 | -24      |                | -24      | mA   |
| $I_{OL}$                | Low-level output current           |           | 24       |                 | 24       |                | 24       | mA   |
| $T_{\Delta t/\Delta v}$ | Input transition rise or fall rate |           | 20       |                 | 20       |                | 20       | °C   |

### 5.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |  | CD74ACT14 |         | UNIT |
|-------------------------------|--|-----------|---------|------|
|                               |  | E         | M       |      |
|                               |  | 14 PINS   | 14 PINS |      |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance | 80        | 86      | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

### 5.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER  | TEST CONDITIONS | $V_{CC}$ | TA = 25°C |     | - 55°C TO 125°C |     | - 40°C TO 85°C |     | UNIT |
|--|-----------------|----------|-----------|-----|-----------------|-----|----------------|-----|------|
|  |                 |          | MIN       | MAX | MIN             | MAX | MIN            | MAX |      |
| $V_{T+}$<br>Positive-going threshold             |                 | 5 V      | 1.4       | 2   | 1.4             | 2   | 1.4            | 2   | V    |
| $V_{T-}$<br>Negative-going threshold             |                 | 5 V      | 0.8       | 1.3 | 0.8             | 1.3 | 0.8            | 1.3 | V    |
| $\Delta V_T$<br>Hysteresis ( $V_{T+} - V_{T-}$ ) |                 | 5 V      | 0.4       |     | 0.4             |     | 0.4            |     | V    |

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                       | TEST CONDITIONS   | V <sub>CC</sub>                         | T <sub>A</sub> = 25°C |      | – 55°C TO 125°C |      | – 40°C TO 85°C |      | UNIT |
|---------------------------------|---|---|-----------------------|------|-----------------|------|----------------|------|------|
|                                 |   |   | MIN                   | MAX  | MIN             | MAX  | MIN            | MAX  |      |
| V <sub>OH</sub>                 | V <sub>I</sub> = V <sub>T+</sub>                            | I <sub>OH</sub> = –50 μA                | 4.5 V                 | 4.4  |                 | 4.4  |                | 4.4  | V    |
|                                 |   | I <sub>OH</sub> = –24 mA                | 4.5 V                 | 3.94 |                 | 3.7  |                | 3.8  |      |
|                                 |   | I <sub>OH</sub> = –50 mA <sup>(1)</sup> | 5.5 V                 |      |                 | 3.85 |                |      |      |
|                                 |   | I <sub>OH</sub> = –75 mA <sup>(1)</sup> | 5.5 V                 |      |                 |      |                | 3.85 |      |
| V <sub>OL</sub>                 | V <sub>I</sub> = V <sub>T–</sub>                            | I <sub>OL</sub> = 50 μA <sup>(1)</sup>  | 4.5 V                 |      | 0.1             |      | 0.1            | 0.1  | V    |
|                                 |   | I <sub>OL</sub> = 24 mA <sup>(1)</sup>  | 4.5 V                 |      | 0.36            |      | 0.5            | 0.44 |      |
|                                 |   | I <sub>OL</sub> = 50 mA <sup>(1)</sup>  | 5.5 V                 |      |                 |      | 1.65           |      |      |
|                                 |   | I <sub>OL</sub> = 75 mA <sup>(1)</sup>  | 5.5 V                 |      |                 |      |                | 1.65 |      |
| I <sub>I</sub>                  | V <sub>I</sub> = V <sub>CC</sub> or GND                     | 5.5 V                                   |                       | ±0.1 |                 | ±1   |                | ±1   | μA   |
| I <sub>CC</sub>                 | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0 | 5.5 V                                   |                       | 4    |                 | 80   |                | 40   | μA   |
| ΔI <sub>CC</sub> <sup>(2)</sup> | V <sub>I</sub> = V <sub>CC</sub> – 2.1 V                    | 4.5 V to 5.5 V                          |                       | 2.4  |                 | 3    |                | 2.8  | mA   |
| C <sub>i</sub>                  |   |   |                       | 10   |                 | 10   |                | 10   | pF   |

- (1) Test one output at a time, not exceeding 1-second duration. Measurement is made by forcing indicated current and measuring voltage to minimize power dissipation. Test verifies a minimum 50-Ω transmission-line drive capability at 85°C and 75-Ω transmission-line drive capability at 125°C.
- (2) Additional quiescent supply current per input pin, TTL inputs high, 1 unit load.

**Table 5-1. Act Input Load Table**

| INPUT | UNIT LOAD |
|-------|-----------|
| A     | 0.21      |

1. Unit load is ΔI<sub>CC</sub> limit specified in electrical characteristics table (e.g., 2.4 mA at 25°C).

## 5.6 Switching Characteristics

over recommended operating free-air temperature range, V<sub>CC</sub> = 5 V ± 0.5 V (unless otherwise noted) (see [Load Circuit and Voltage Waveforms](#))

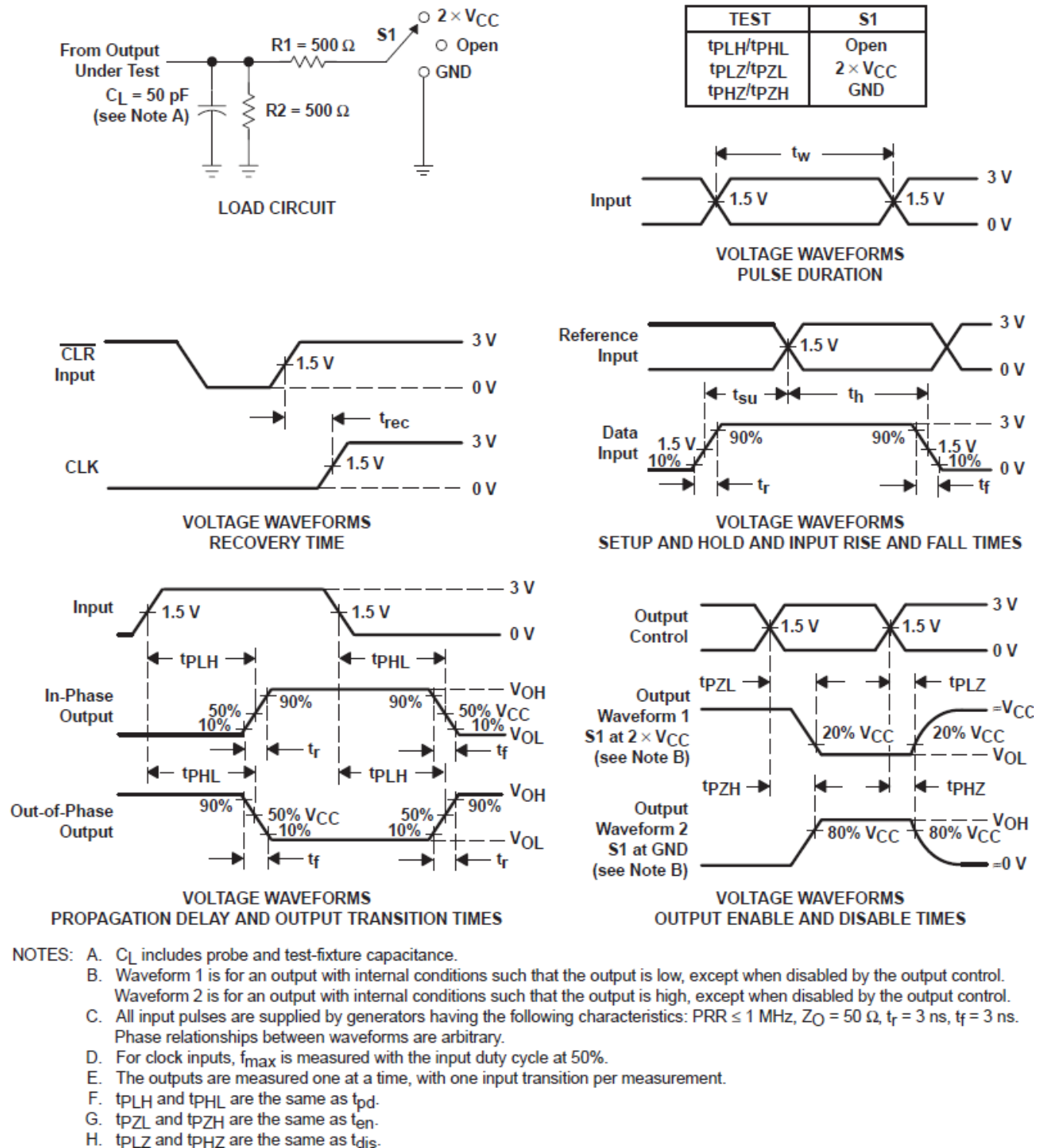
| PARAMETER        | FROM (INPUT) | TO (OUTPUT) | – 55°C to 125°C |      | – 40°C to 85°C |      | UNIT |
|------------------|--------------|-------------|-----------------|------|----------------|------|------|
|                  |              |             | MIN             | MAX  | MIN            | MAX  |      |
| t <sub>PLH</sub> | A            | Y           | 3.6             | 14.5 | 3.7            | 13.2 | ns   |
| t <sub>PHL</sub> |              |             | 2.4             | 9.5  | 2.4            | 8.6  |      |

## 5.7 Operating Characteristics

V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C

| PARAMETER       |                               | TYP | UNIT |
|-----------------|-------------------------------|-----|------|
| C <sub>pd</sub> | Power dissipation capacitance | 45  | pF   |

## 6 Parameter Measurement Information



**Figure 6-1. Load Circuit and Voltage Waveforms**

## 7 Detailed Description

### 7.1 Overview

The CD74ACT14 contains six independent inverters. This device performs the Boolean function  $Y = \bar{A}$ .

Each circuit functions as an independent inverter, but because of the Schmitt action, the inverters have different input threshold levels for positive-going ( $V_{T+}$ ) and negative-going ( $V_{T-}$ ) signals.

### 7.2 Functional Block Diagram



**Figure 7-1. Logic Diagram, Each Inverter (Positive Logic)**

### 7.3 Device Functional Modes

**Table 7-1. Function Table (Each Inverter)**

| INPUT | OUTPUT |
|-------|--------|
| A     | Y      |
| H     | L      |
| L     | H      |

## 8 Device and Documentation Support

### 8.1 Documentation Support (Analog)

#### 8.1.1 Related Documentation

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

**Table 8-1. Related Links**

| PARTS     | PRODUCT FOLDER             | SAMPLE & BUY               | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|-----------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| CD74ACT14 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

### 8.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 8.3 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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### 8.4 Trademarks

TI E2E™ is a trademark of Texas Instruments.

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### 8.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 8.6 Glossary

#### [TI Glossary](#)

This glossary lists and explains terms, acronyms, and definitions.



## 9 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| CD74ACT14E       | ACTIVE        | PDIP         | N               | 14   | 25          | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | -55 to 125   | CD74ACT14E              | <a href="#">Samples</a> |
| CD74ACT14M96     | ACTIVE        | SOIC         | D               | 14   | 2500        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -55 to 125   | ACT14M                  | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD74ACT14M96 | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD74ACT14M96 | SOIC         | D               | 14   | 2500 | 356.0       | 356.0      | 35.0        |

**TUBE**


\*All dimensions are nominal

| Device     | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CD74ACT14E | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74ACT14E | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



4040047-5/M 06/11

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  -  Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  -  Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

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